

L Number	Hits	Search Text	DB	Time stamp
1	559	hot adj plate and "300" with diameter	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:28
3	5	(hot adj plate and "300" with diameter) and support\$3 adj case with metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 11:54
4	26	(hot adj plate and "300" with diameter) and case near metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 11:54
2	87	(hot adj plate and "300" with diameter) and case with metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 11:56
5	5	hot adj plate same diameter near substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:03
6	184	hot adj plate same diameter same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:03
7	6	(hot adj plate same diameter same substrate) and support with metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:24
8	6	((hot adj plate same diameter same substrate) and support with metal) and temperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:08
9	10	(hot adj plate same diameter same substrate) and (case or casing or housing) with metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:15
10	11	(hot adj plate same diameter same substrate) and (case or casing or housing) with metal\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:14
11	27	(hot adj plate same diameter same substrate) and (case or casing or housing) same metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:15
12	56	(hot adj plate and "300" with diameter) and support with metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:24

13	13	hot adj plate same support same cas\$3 with metal\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/07 12:29
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